SiR800ADP **Vishay Siliconix**

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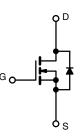
PRODUCT SUMMARY	
V _{DS} (V)	20
$R_{DS(on)}$ max. (Ω) at V_{GS} = 10 V	0.00135
$R_{DS(on)}$ max. (Ω) at V_{GS} = 4.5 V	0.00175
$R_{DS(on)}$ max. (Ω) at V_{GS} = 2.5 V	0.00460
Q _g typ. (nC)	18.2
I _D (A)	177 ^g
Configuration	Single

FEATURES

- Optimized Q_g , Q_{gd} , and Q_{gd}/Q_{gs} ratio reduces switching related power loss
- 100 % R_a and UIS tested
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- Synchronous rectification
- High power density DC/DC
- Synchronous buck converter
- Load switching



N-Channel MOSFET

ORDERING INFORMATION

Package	PowerPAK SO-8
Lead (Pb)-free and halogen-free	SiR800ADP-T1-GE3

ABSOLUTE MAXIMUM BATINGS (T. - 25 °C, unless otherwise noted)

PARAMETER		SYMBOL	LIMIT	UNIT
Drain-source voltage		V _{DS}	20	V
Gate-source voltage		V _{GS}	+12 / -8	v
Continuous drain current (T _J = 150 °C)	T _C = 25 °C		177	
	T _C = 70 °C		142	
	T _A = 25 °C		50.2 ^{b, c}	
	T _A = 70 °C	1	40.2 ^{b, c}	•
Pulsed drain current (t = 100 µs)		I _{DM}	150	— A
	T _C = 25 °C		56.8	
Continuous source-drain diode current	T _A = 25 °C	I _S	4.5 ^{b, c}	
Single pulse avalanche current		I _{AS}	20	
Single pulse avalanche energy L = 0.1 mH		E _{AS}	20	mJ
	T _C = 25 °C		62.5	
Manimum and a disain sting	T _C = 70 °C		40	14/
Maximum power dissipation	T _A = 25 °C	P _D	5 b, c	W
	T _A = 70 °C	1	3.2 ^{b, c}	
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +150	•••
Soldering recommendations (peak temperature) ^c			260	°C

THERMAL RESISTANCE RATINGS

PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT
Maximum junction-to-ambient b	t ≤ 10 s	R _{thJA}	20	25	°C/W
Maximum junction-to-case (drain)	Steady state	R _{thJC}	1.7	2	0/10

Notes

a. Package limited

Surface mounted on 1" x 1" FR4 board b.

 $t = 10 \, s$ c.

Rework conditions: manual soldering with a soldering iron is not recommended for leadless components e.

Maximum under steady state conditions is 70 °C/W f.

g. $T_C = 25 \ ^{\circ}C$

S18-0652-Rev. A, 02-Jul-2018

1

Document Number: 79335

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RoHS

COMPLIANT HALOGEN FREE

TrenchFET[®] Gen IV power MOSFET

See solder profile (<u>www.vishay.com/doc?73257</u>). The PowerPAK SO-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection d.

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SiR800ADP

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PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static			•			
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0 V, I_D = 250 \mu A$	20	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_J$	I _D = 10 mA	-	18	-	
V _{GS(th)} temperature coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 250 μA	-	-3.6	-	mv/-C
Gate-source threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	0.6	-	1.5	V
Gate-source leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = +12 / -8 V$	-	-	100	nA
Zara acta valtaga drain avreat		$V_{DS} = 20 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-	-	1	
Zero gate voltage drain current	IDSS	V_{DS} = 20 V, V_{GS} = 0 V, T_{J} = 70 °C	-	-	15	μΑ
On-state drain current ^a	I _{D(on)}	$V_{DS} \geq$ 10 V, V_{GS} = 10 V	40	-	-	Α
		$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 10 \text{ A}$	-	0.00112	0.00135	
Drain-source on-state resistance ^a	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 10 \text{ A}$	$\begin{array}{c c c c c c c c c c c c c c c c c c c $			
		$V_{GS} = 2.5 \text{ V}, \text{ I}_{D} = 10 \text{ A}$			0.00460	
Forward transconductance ^a		$V_{DS} = 15 \text{ V}, \text{ I}_{D} = 10 \text{ A}$	-	60	-	S
Dynamic ^b						
Input capacitance	C _{iss}		-	3415	-	pF
Output capacitance	C _{oss}	$V_{DS} = 10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	-	1290	-	
Reverse transfer capacitance	C _{rss}		-	72	-	
Tatal asta shawar	0	$V_{DS} = 10 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 10 \text{ A}$	-	35.2	53	
Total gate charge	Qg		-	18.2	27.5	
Gate-source charge	Q _{gs}	V_{DS} = 10 V, V_{GS} = 4.5 V, I_{D} = 10 A	-	7.3	-	nc
Gate-drain charge	Q _{gd}		-	3.6	-	
Gate resistance	Rg	f = 1 MHz	0.4	0.85	1.4	Ω
Turn-on delay time	t _{d(on)}		-	20	40	
Rise time	t _r	$V_{DD} = 10 \text{ V}, \text{ R}_{L} = 1 \Omega, \text{ I}_{D} \cong 10 \text{ A},$	-	13	26	
Turn-off delay time	t _{d(off)}	$V_{\text{GEN}} = 10 \text{ V}, \text{ R}_{\text{g}} = 1 \Omega$	-	40	80	
Fall time	t _f	V_{DD} = 10 V, R_L = 1 Ω , $I_D \cong$ 10 A,		10	20	
Turn-on delay time	t _{d(on)}		-	12	24	ns
Rise time	tr	V_{DD} = 10 V, R_L = 1 Ω , $I_D \cong$ 10 A,	-	5	10	1
Turn-off delay time	t _{d(off)}	V_{GEN} = 4.5 V, R_g = 1 Ω	-	34	68	
Fall time	t _f		-	6	10	
Drain-Source Body Diode Characteristi	cs					
Continuous source-drain diode current	I _S	T _C = 25 °C	-	-	56.8	•
Pulse diode forward current	I _{SM}		-	-	150	A
Body diode voltage	V _{SD}	$I_{\rm S} = 5$ A, $V_{\rm GS} = 0$ V	-	0.73	1.1	V
Body diode reverse recovery time	t _{rr}		-	32	64	ns
Body diode reverse recovery charge	Q _{rr}	I _F = 10 A, di/dt = 100 A/μs,	-	21	42	nC
Reverse recovery fall time	ta	$T_{\rm J} = 25 ^{\circ}{\rm C}$	-	16	-	
Reverse recovery rise time	t _b		-	16	-	ns

Notes

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %

b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

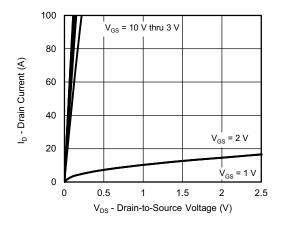
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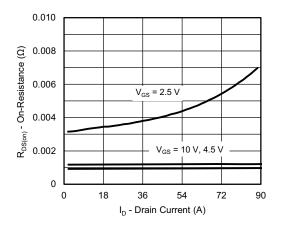
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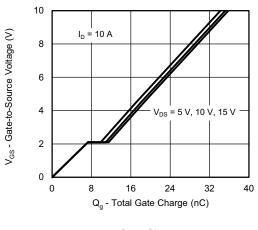
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



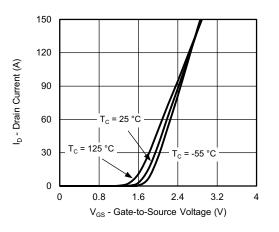
Output Characteristics



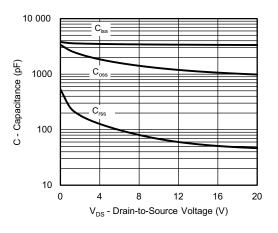
On-Resistance vs. Drain Current and Gate Voltage



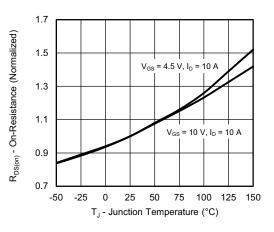
Gate Charge



Transfer Characteristics







On-Resistance vs. Junction Temperature

S18-0652-Rev. A, 02-Jul-2018

3

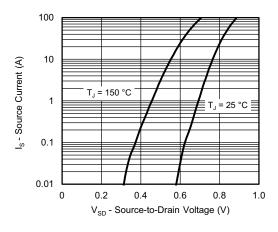
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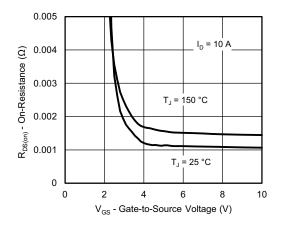


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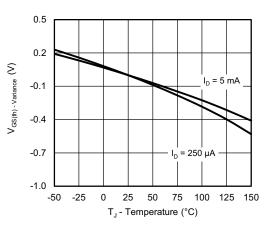
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



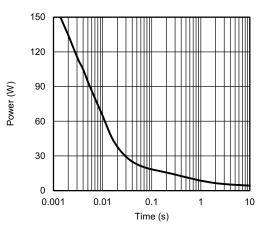
Source-Drain Diode Forward Voltage



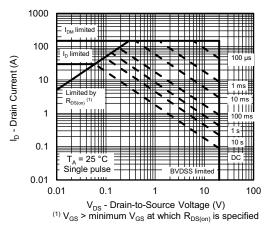
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage



Single Pulse Power, Junction-to-Ambient



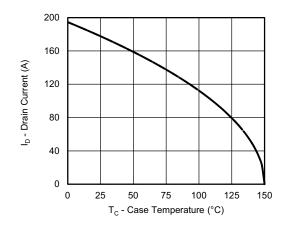
Safe Operating Area, Junction-to-Ambient

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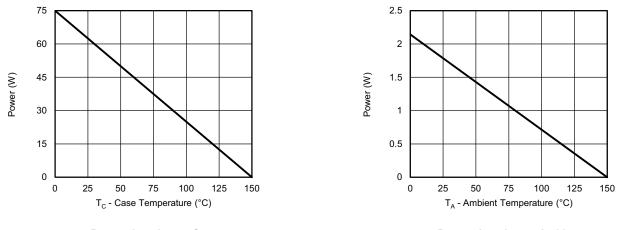


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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Current Derating ^a



Power, Junction-to-Case

Power, Junction-to-Ambient

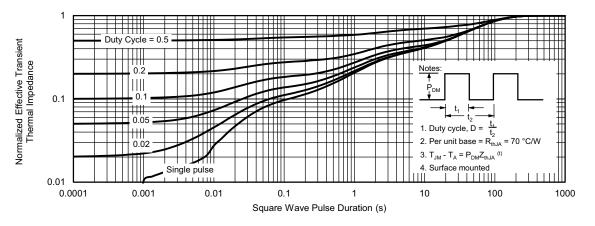
Note

a. The power dissipation P_D is based on T_J max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit

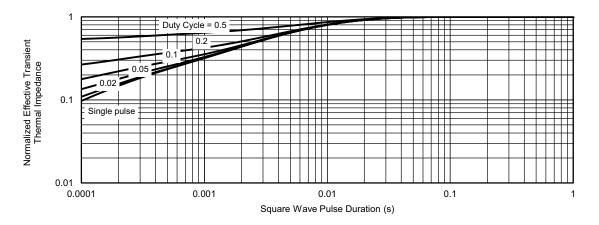


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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see www.vishay.com/ppg?79335.

D2

E3

Backside View of Dual Pad



Vishay Siliconix

PowerPAK[®] SO-8, (Single/Dual)



Notes

1. Inch will govern.

2 Dimensions exclusive of mold gate burrs.

3. Dimensions exclusive of mold flash and cutting burrs.

DIM.	MILLIMETERS			INCHES				
	MIN.	NOM.	MAX.	MIN.	NOM.	MAX		
А	0.97	1.04	1.12	0.038	0.041	0.044		
A1		-	0.05	0	-	0.00		
b	0.33	0.41	0.51	0.013	0.016	0.02		
С	0.23	0.28	0.33	0.009	0.011	0.01		
D	5.05	5.15	5.26	0.199	0.203	0.20		
D1	4.80	4.90	5.00	0.189	0.193	0.19		
D2	3.56	3.76	3.91	0.140	0.148	0.154		
D3	1.32	1.50	1.68	0.052	0.059	0.066		
D4		0.57 typ.				0.0225 typ.		
D5		3.98 typ.			0.157 typ.			
E	6.05	6.15	6.25	0.238	0.242	0.246		
E1	5.79	5.89	5.99	0.228	0.232	0.23		
E2	3.48	3.66	3.84	0.137	0.144	0.15		
E3	3.68	3.78	3.91	0.145	0.149	0.154		
E4		0.75 typ.			0.030 typ.			
е		1.27 BSC		0.050 BSC				
К		1.27 typ.		0.050 typ.				
K1	0.56	-	-	0.022	-	-		
Н	0.51	0.61	0.71	0.020	0.024	0.028		
L	0.51	0.61	0.71	0.020	0.024	0.028		
L1	0.06	0.13	0.20	0.002	0.005	0.008		
θ	0°	-	12°	0°	-	12°		
W	0.15	0.25	0.36	0.006	0.010	0.014		
М		0.125 typ.			0.005 typ.			

1



Application Note 826

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RECOMMENDED MINIMUM PADS FOR PowerPAK® SO-8 Single



Recommended Minimum Pads Dimensions in Inches/(mm)

Return to Index



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